



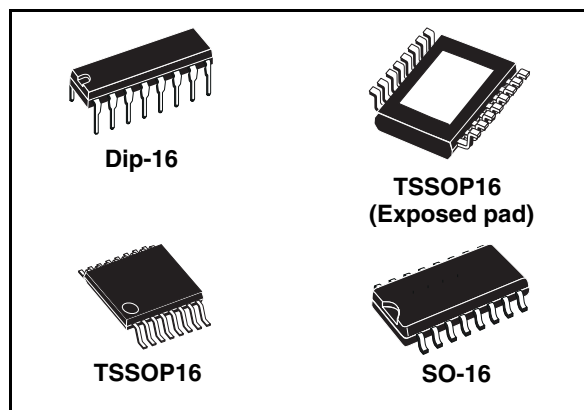
STP08CP05

Low voltage, low current power 8-bit shift register

Preliminary Data

Features

- Low voltage power supply down to 3V
- 8 constant current output channels
- Adjustable output current through external resistor
- Serial Data IN/Parallel data OUT
- 3.3V micro driver-able
- Output current: 5-100mA
- 30MHz clock frequency
- Available in high thermal efficiency TSSOP exposed pad
- ESD protection 2.5kV HBM, 200V MM



Description

The STP08CP05 is a monolithic, low voltage, low current, power 8-bit shift register designed for LED panel displays. The STP08CP05 contains a 8-bit serial-in, parallel-out shift register that feeds a 8-bit D-type storage register. In the output stage, eight regulated current sources were designed to provide 5-100mA constant current to drive the LEDs, the output current setup time is 10ns (typ), thus improving the system performance.

The STP08CP05 is backward compatible in functionality and footprint with STP8C/L596. Through an external resistor, users can adjust the STP08CP05 output current, controlling in this way the light intensity of LEDs, in addition, user can adjust LED's brightness intensity from 0% to 100% via $\overline{OE}$ pin.

The STP08CP05 guarantees a 20V output driving capability, allowing users to connect more LEDs in series. The high clock frequency, 30 MHz, also satisfies the system requirement of high volume data transmission. The 3.3V of voltage supply is useful for applications that interface with any micro from 3.3V. Compared with a standard TSSOP package, the TSSOP exposed pad increases heat dissipation capability by a 2.5 factor.

Table 1. Device summary

Order codes	Package	Packaging
STP08CP05B1R	DIP-16	25 parts per tube
STP08CP05MTR	SO-16 (Tape & Reel)	2500 parts per reel
STP08CP05TTR	TSSOP16 (Tape & Reel)	2500 parts per reel
STP08CP05XTTR	TSSOP16 Exposed-Pad (Tape & Reel)	2500 parts per reel

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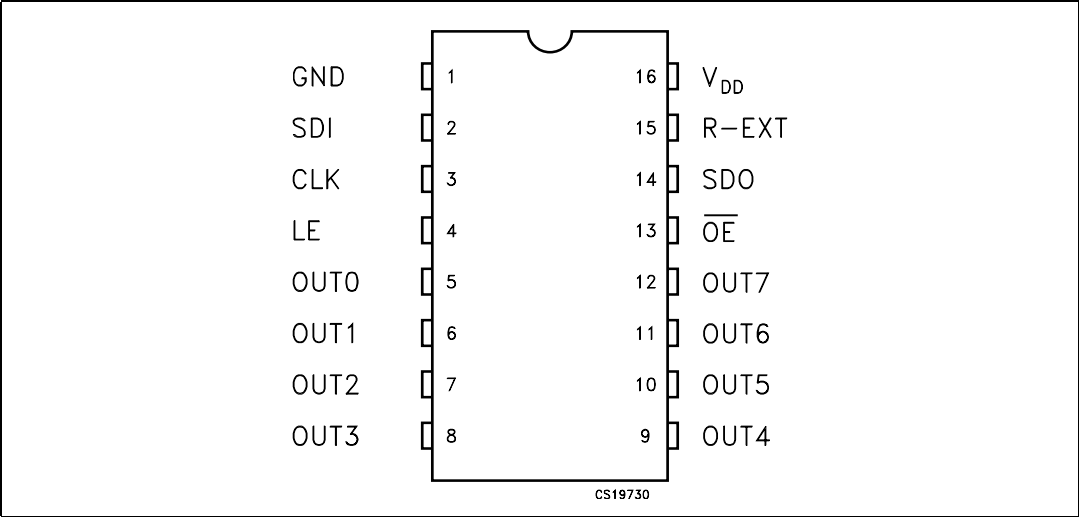
1 Summary description

Table 2. Typical current accuracy

Output voltage	Current accuracy		Output current
	Between bits	Between ICs	
≥1.3V	±1.5%	±3%	20 to 100mA

1.1 Pin connection and description

Figure 1. Connections diagram



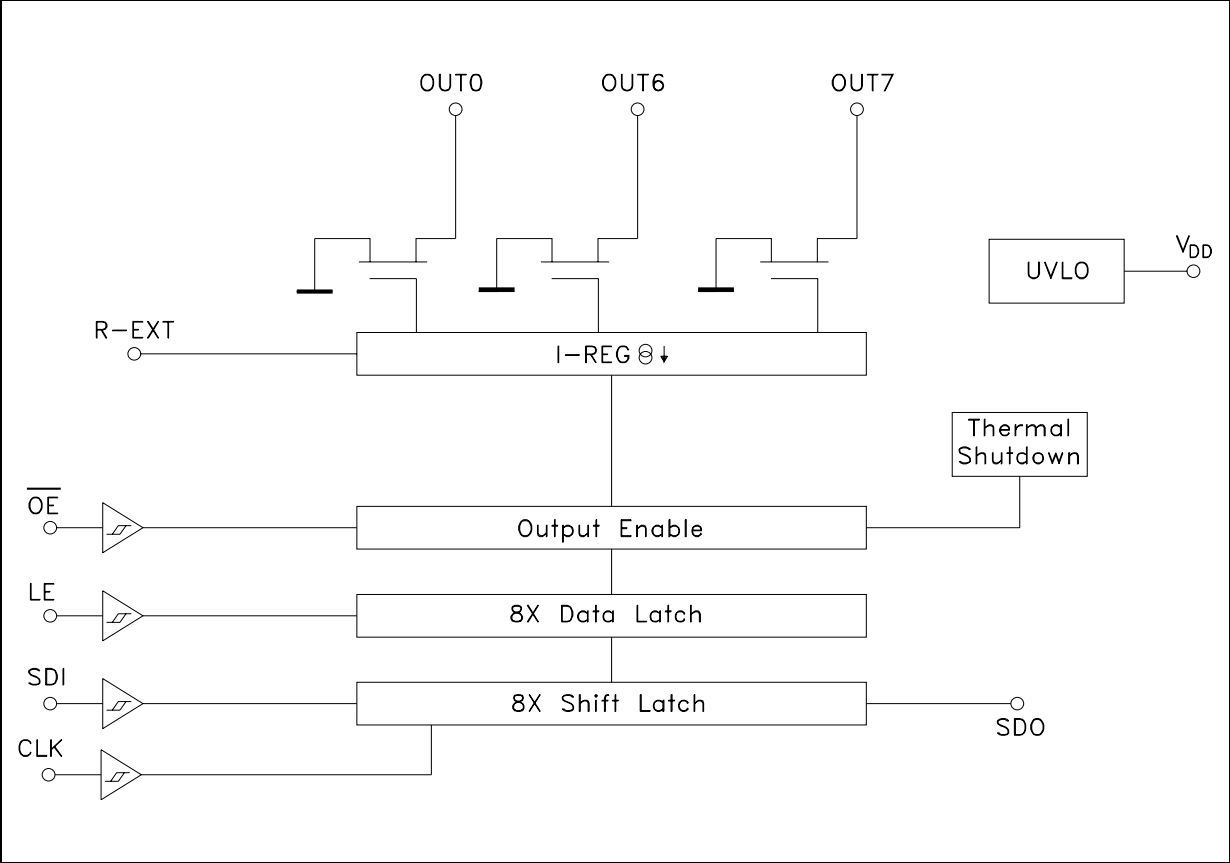
Note: The Exposed-pad is electrically not connected

Table 3. Pin description

PIN N°	Symbol	Name and function
1	GND	Ground terminal
2	SDI	Serial data input terminal
3	CLK	Clock input terminal
4	LE	Latch input terminal
5-12	OUT 0-7	Output terminal
13	$\overline{OE}$	Output enable input terminal (active low)
14	SDO	Serial data out terminal
15	R-EXT	Constant current programming
16	V _{DD}	5V Supply voltage terminal

2 Block diagram

Figure 2. Block diagram



3 Maximum rating

Stressing the device above the rating listed in the “Absolute Maximum Ratings” table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

3.1 Absolute maximum ratings

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DD}	Supply voltage I_{GND}	0 to 7	V
V_O	Output voltage	-0.5 to 20	V
I_O	Output current	100	mA
I_{GND}	GND terminal current	800	mA
f_{CLK}	Clock frequency	50	MHz
T_{OPR}	Operating temperature range	-40 to +125	°C
T_{STG}	Storage temperature range	-55 to +150	°C

3.2 Thermal data

Table 5. Thermal data

Symbol	Parameter	DIP-16	SO-16	TSSOP-16	TSSOP-16 ⁽¹⁾ (exposed pad)	Unit
R_{thJA}	Thermal resistance junction-ambient	60	75	85	37.5	°C/W

1. The Exposed-Pad should be soldered to the PBC to realize the thermal benefits

3.3 Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V_{DD}	Supply voltage		3.0		5.5	V
V_O	Output voltage				20	V
I_O	Output current	OUTn	5		100	mA
I_{OH}	Output current	SERIAL-OUT			+1	mA
I_{OL}	Output current	SERIAL-OUT			-1	mA
V_{IH}	Input voltage		$0.7V_{DD}$		$V_{DD}+0.3$	V
V_{IL}	Input voltage		-0.3		$0.3V_{DD}$	V
t_{wLAT}	LE pulse width	$V_{DD} = 3.0 \text{ to } 5.0\text{V}$	20			ns
t_{wCLK}	CLK pulse width		20			ns
t_{wEN}	$\overline{OE}$ pulse width		200			ns
$t_{SETUP(D)}$	Setup time for DATA		7			ns
$t_{HOLD(D)}$	Hold time for DATA		4			ns
$t_{SETUP(L)}$	Setup time for LATCH		15			ns
f_{CLK}	Clock frequency	Cascade operation ⁽¹⁾			30	MHz

1. In order to achieve high cascade data transfer, please consider t_r/t_f timings carefully.

4 Electrical characteristics

Table 7. Electrical characteristics

($V_{DD}=3.3V$ to $5V$, $T = 25^{\circ}C$, unless otherwise specified.)

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V_{IH}	Input voltage high level		$0.7V_{DD}$		V_{DD}	V
V_{IL}	Input voltage low level		GND		$0.3V_{DD}$	V
I_{OH}	Output leakage current	$V_{OH} = 20V$		0.5	10	μA
V_{OL}	Output voltage (Serial-OUT)	$I_{OL} = 1mA$		0.03	0.4	V
V_{OH}	Output voltage (Serial-OUT)	$I_{OH} = -1mA$	$V_{OH} - V_{DD} = -0.4V$			V
I_{OL1}	Output current	$V_O = 0.3V$, $R_{ext} = 3.9k\Omega$	4.25	5	5.75	mA
I_{OL2}		$V_O = 0.3V$, $R_{ext} = 970\Omega$	19.4	20	20.6	
I_{OL3}		$V_O = 1.3V$, $R_{ext} = 190\Omega$	97	100	103	
ΔI_{OL1}	Output current error between bit (All Output ON)	$V_O = 0.3V$, $R_{EXT} = 3.9k\Omega$		± 5	± 8	%
ΔI_{OL2}		$V_O = 0.3V$, $R_{EXT} = 970\Omega$		± 1.5	± 2.75	
ΔI_{OL3}		$V_O = 1.3V$, $R_{EXT} = 190\Omega$		± 1.2	± 2.5	
$R_{SIN(up)}$	Pull-up resistor		150	300	600	$K\Omega$
$R_{SIN(down)}$	Pull-down resistor		100	200	400	$K\Omega$
$I_{DD(OFF1)}$	Supply current (OFF)	$R_{EXT} = 980$ OUT 0 to 7 = OFF		4	5	mA
$I_{DD(OFF2)}$		$R_{EXT} = 250$ OUT 0 to 7 = OFF		11.2	13.5	
$I_{DD(ON1)}$	Supply current (ON)	$R_{EXT} = 980$ OUT 0 to 7 = ON		4.5	5	
$I_{DD(ON2)}$		$R_{EXT} = 250$ OUT 0 to 7 = ON		11.7	13.5	
Thermal	Thermal protection ⁽¹⁾			170		$^{\circ}C$

1. Guaranteed by desing (not tested)
The thermal protection switches OFF only the outputs

5 Switching characteristics

Table 8. Switching characteristics ($V_{DD} = 5V$, $T = 25^{\circ}C$, unless otherwise specified.)

Symbol	Parameter	Test conditions		Min	Typ	Max	Unit	
t _{PLH1}	Propagation delay time, CLK- $\overline{OUTn}$, LE = H, $\overline{OE}$ = L	V _{DD} = 3.3 V V _{IL} = GND I _O = 20mA R _{EXT} = 1KΩ	V _{IH} = V _{DD} C _L = 10pF V _L = 3.0 V R _L = 60 Ω	V _{DD} = 3.3V		35	70	ns
				V _{DD} = 5V		18	35	
t _{PLH2}	Propagation delay time, LE - $\overline{OUTn}$, $\overline{OE}$ = L			V _{DD} = 3.3V		48	90	ns
				V _{DD} = 5V		30	60	
t _{PLH3}	Propagation delay time, $\overline{OE}$ - $\overline{OUTn}$, LE = H			V _{DD} = 3.3V		55	110	ns
				V _{DD} = 5V		36	75	
t _{PLH}	Propagation delay time, CLK-SDO			V _{DD} = 3.3V		7	14	ns
				V _{DD} = 5V		4	8	
t _{PHL1}	Propagation delay time, CLK- $\overline{OUTn}$, LE = H, $\overline{OE}$ = L			V _{DD} = 3.3V		10	20	ns
				V _{DD} = 5V		7	14	
t _{PHL2}	Propagation delay time, LE - $\overline{OUTn}$, $\overline{OE}$ = L			V _{DD} = 3.3V		24	50	ns
				V _{DD} = 5V		20	40	
t _{PHL3}	Propagation delay time, $\overline{OE}$ - $\overline{OUTn}$, LE = H			V _{DD} = 3.3V		20	40	ns
				V _{DD} = 5V		17	35	
t _{PHL}	Propagation delay time, CLK-SDO			V _{DD} = 3.3V		22	30	ns
				V _{DD} = 5V		18	25	
t _{ON}	Output rise time 10~90% of voltage waveform	V _{DD} = 3.3V		25	60	ns		
		V _{DD} = 5V		10	25			
t _{OFF}	Output fall time 90~10% of voltage waveform	V _{DD} = 3.3V		5	15	ns		
		V _{DD} = 5V		4	12			
t _r	CLK rise time ⁽¹⁾					5000	ns	
t _f	CLK fall time ⁽¹⁾					5000	ns	

1. In order to achieve high cascade data transfer, please consider t_r/t_f timings carefully.

6 Equivalent circuit and outputs

Figure 3. $\overline{\text{OE}}$ terminal

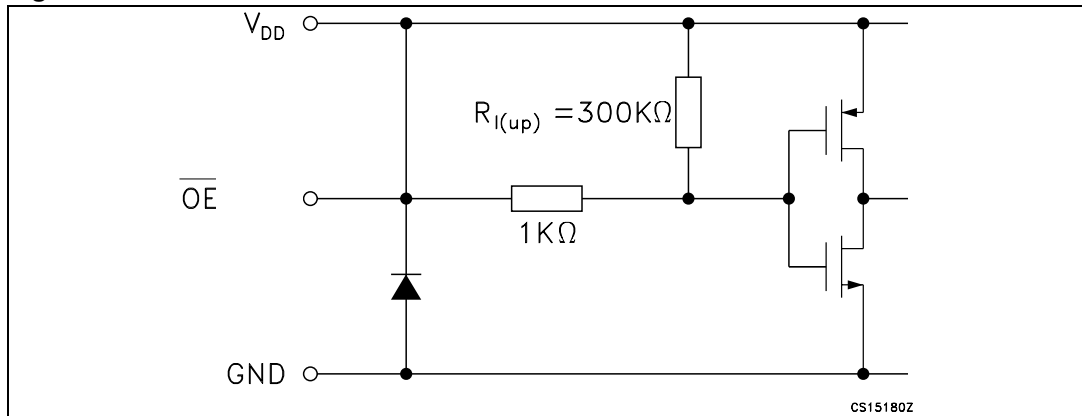


Figure 4. LE terminal

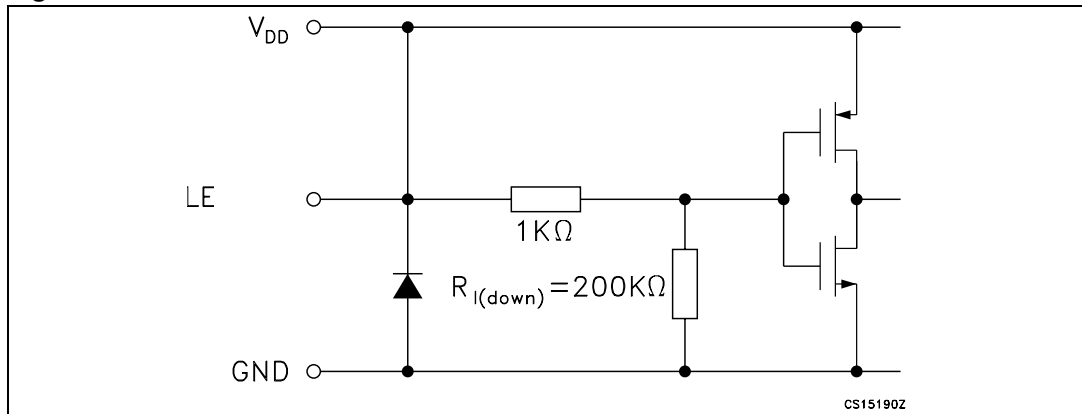


Figure 5. CLK, SDI terminal

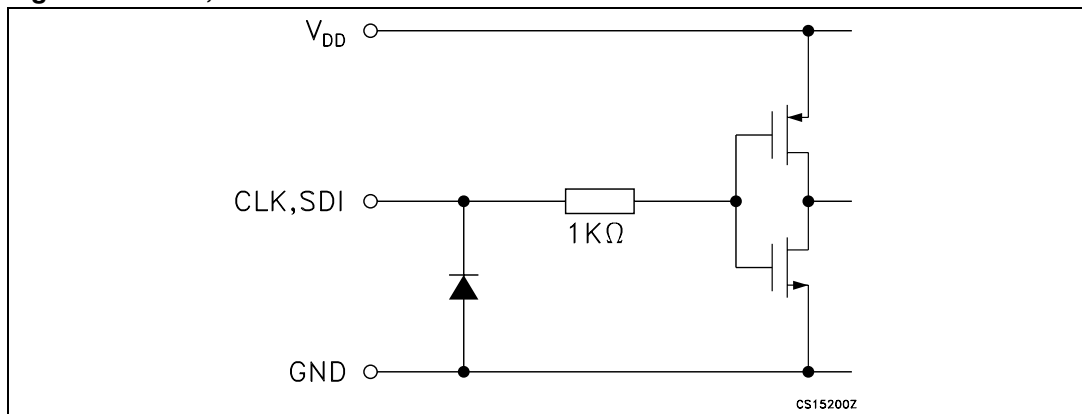
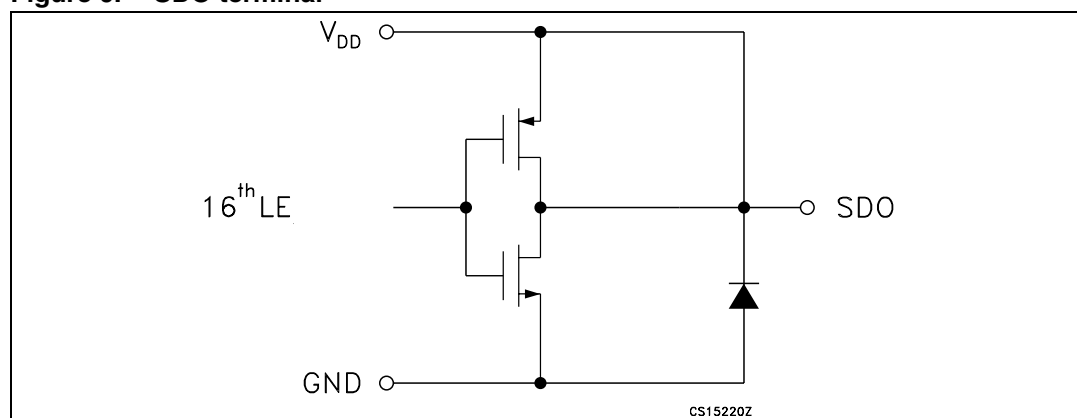


Figure 6. SDO terminal



7 Truth table and timing diagram

7.1 Truth table

Table 9. Truth table

Clock	LE	$\overline{OE}$	SDI	$\overline{OUT0}$ $\overline{OUT0}$ $\overline{OUT7}$	SDO
	H	L	Dn	Dn Dn -5 Dn -7	Dn -7
	L	L	Dn + 1	No Change	Dn -7
	H	L	Dn + 2	$\overline{Dn + 2}$ $\overline{Dn - 3}$ $\overline{Dn - 5}$	Dn -5
	X	L	Dn + 3	$\overline{Dn + 2}$ $\overline{Dn - 3}$ $\overline{Dn - 5}$	Dn -5
	X	H	Dn + 3	OFF	Dn -5

Note: $OUT0$ to $OUT7$ = ON when Dn = H; $OUT0$ to $OUT7$ = OFF when Dn = L.

7.2 Timing diagram

Figure 7. Timing diagram

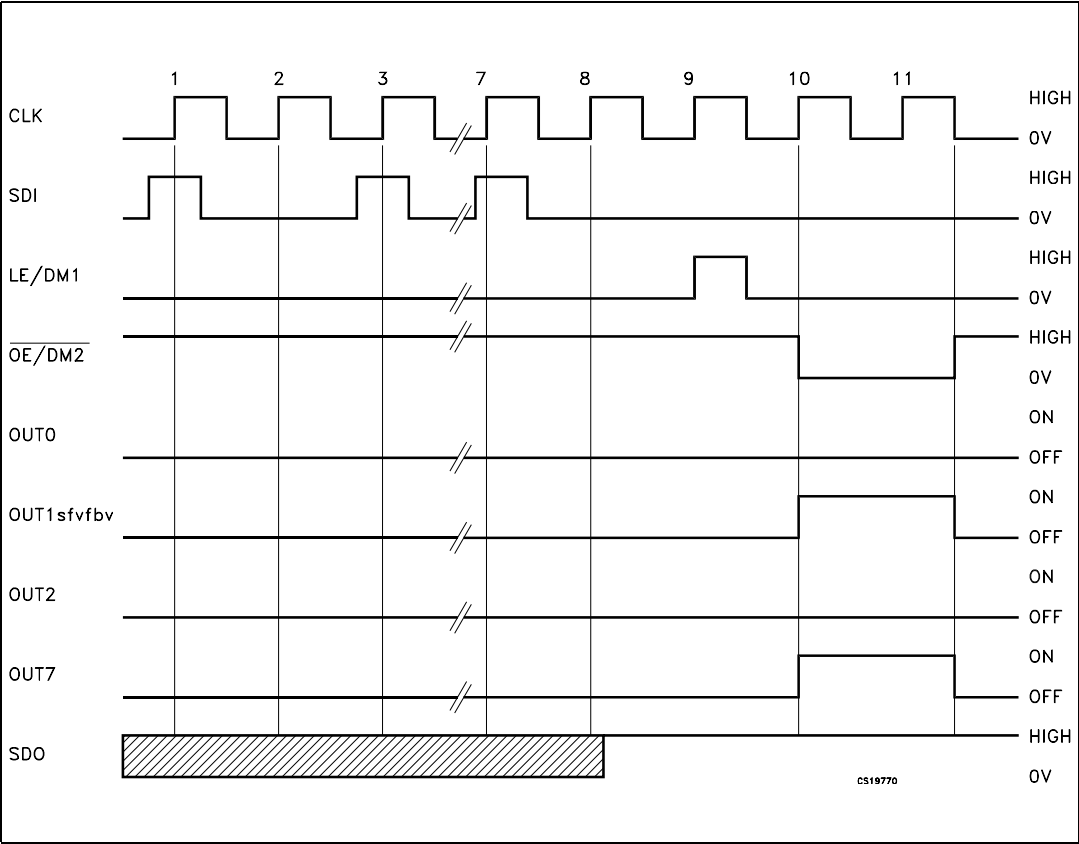


Figure 8. Clock, serial-in, serial-out

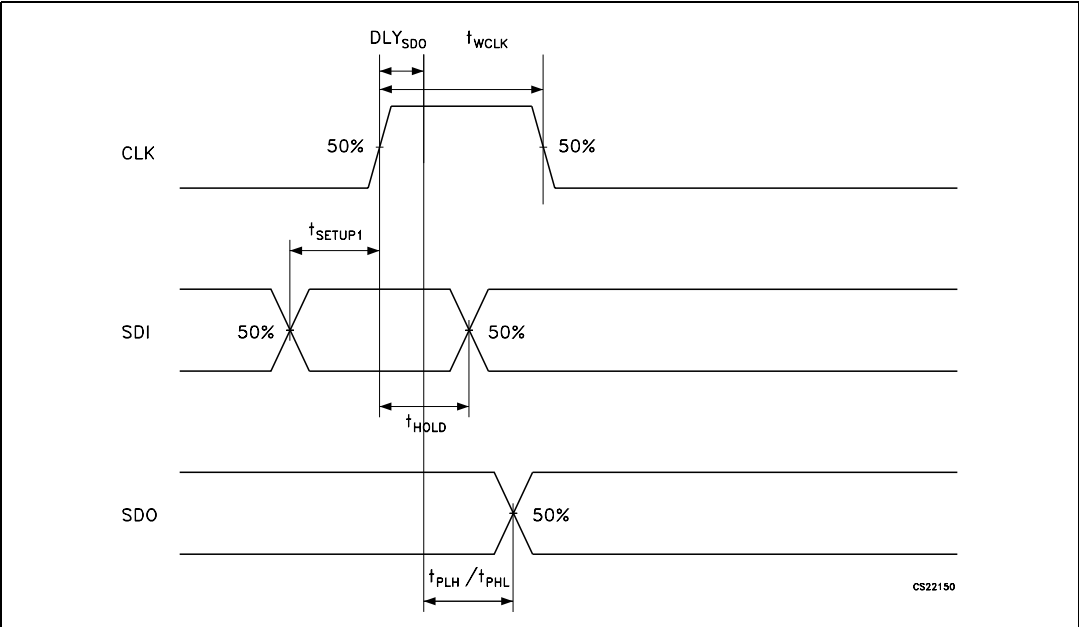


Figure 9. Clock, serial-in, latch, enable, outputs

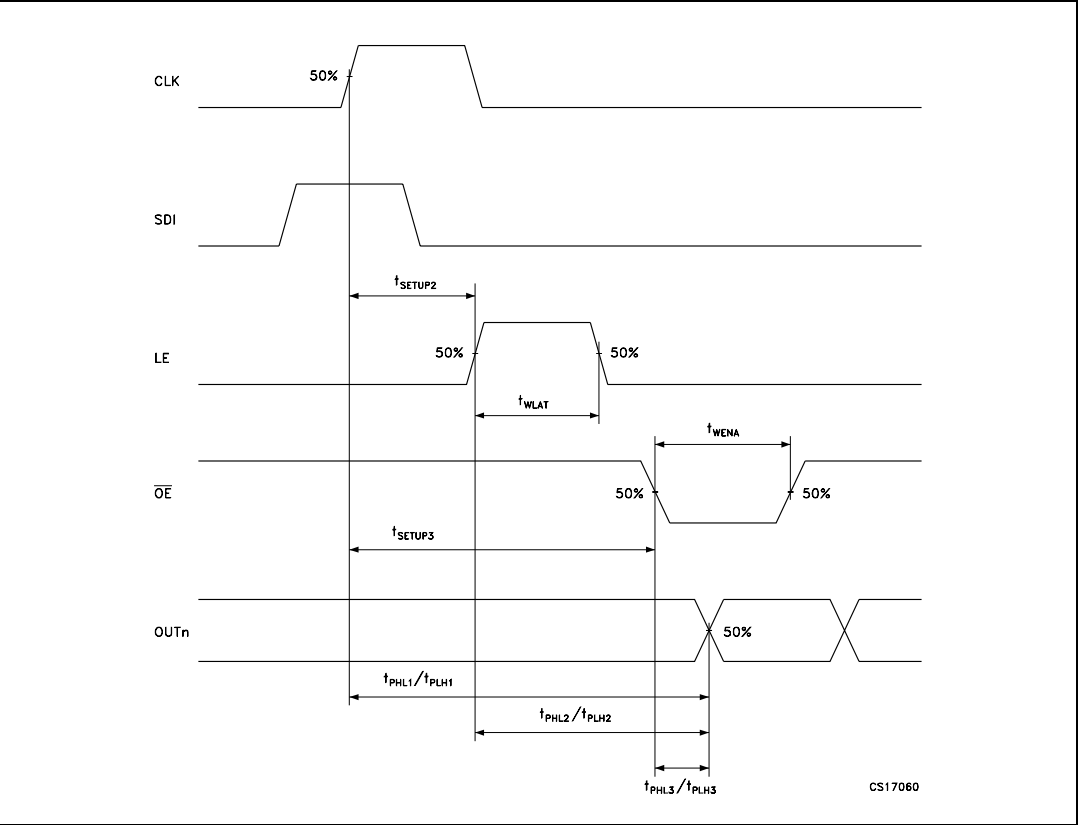
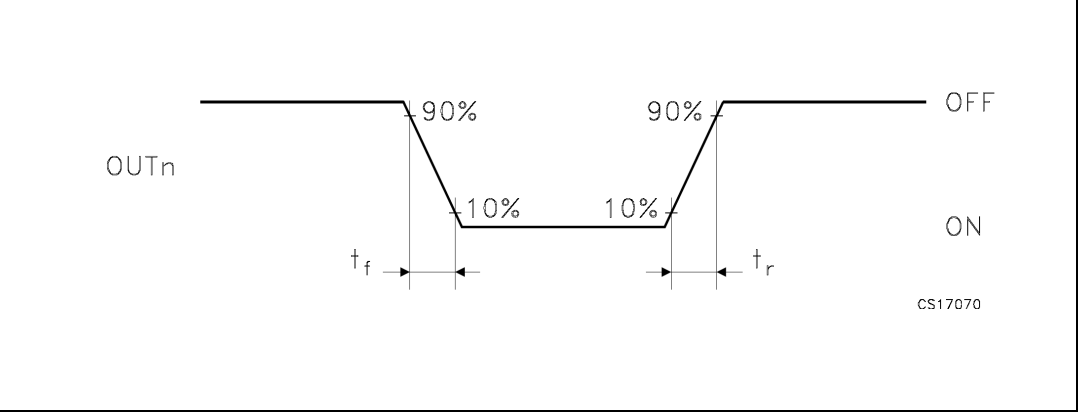


Figure 10. Outputs



8 Typical characteristics

Figure 11. Output current- R_{EXT} resistor

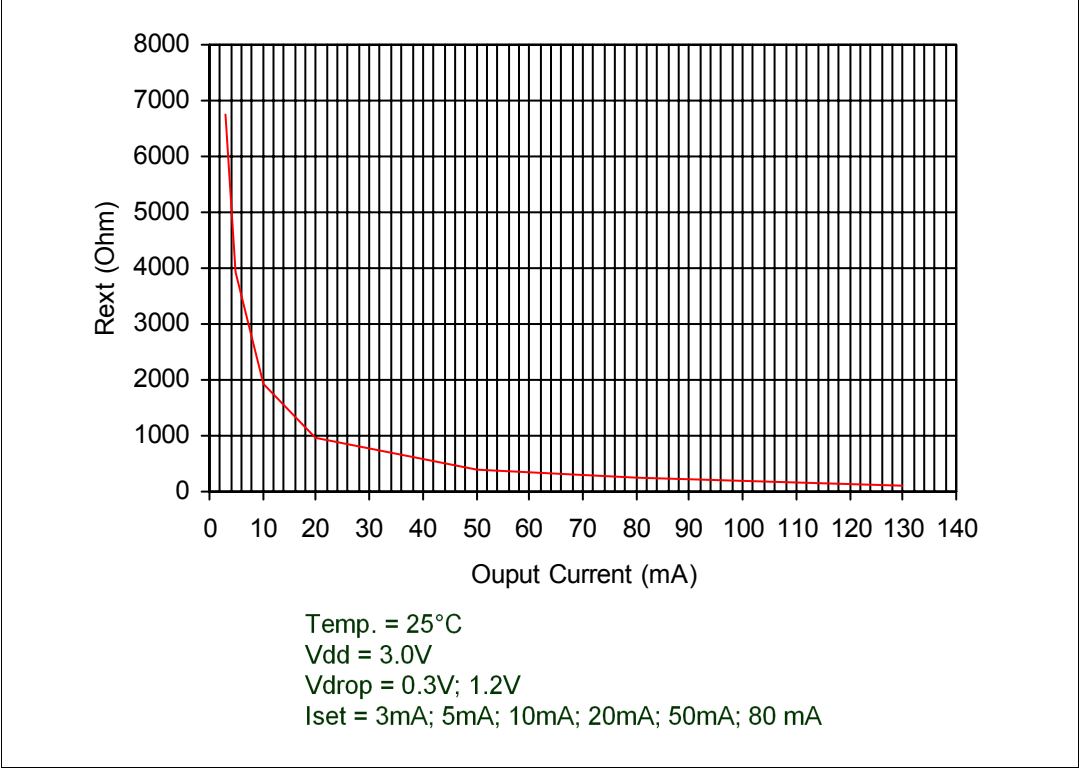
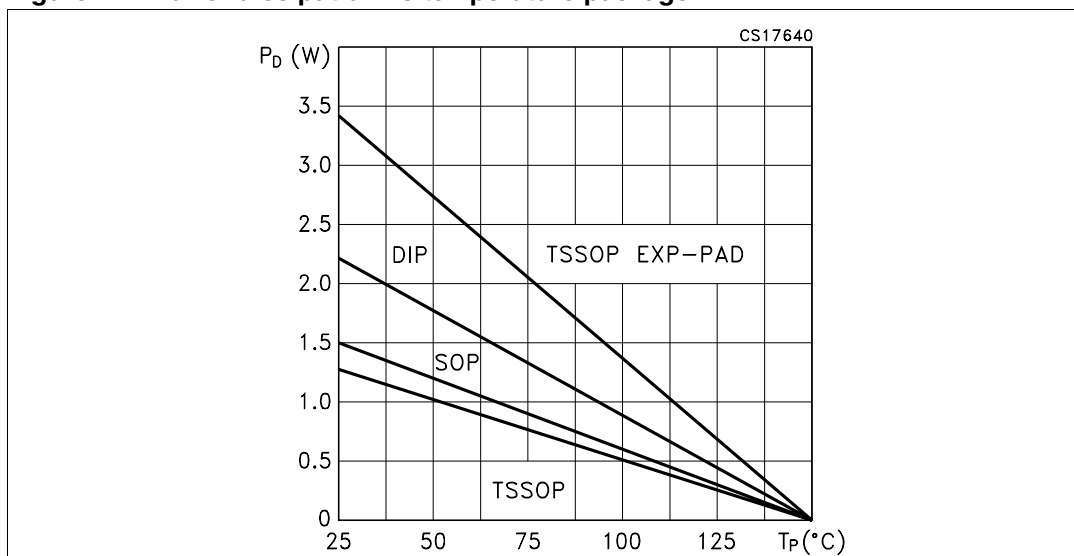


Table 10. Output current- R_{EXT} resistor

Output Current (mA)	3	5	10	20	50	80	130
Rext (Ω)	6740	3930	1913	963	386	241	124

Figure 12. Power dissipation vs temperature package

Note: The Exposed-Pad should be soldered to the PBC to realize the thermal benefits.

9 Test circuit

Figure 13. DC characteristics

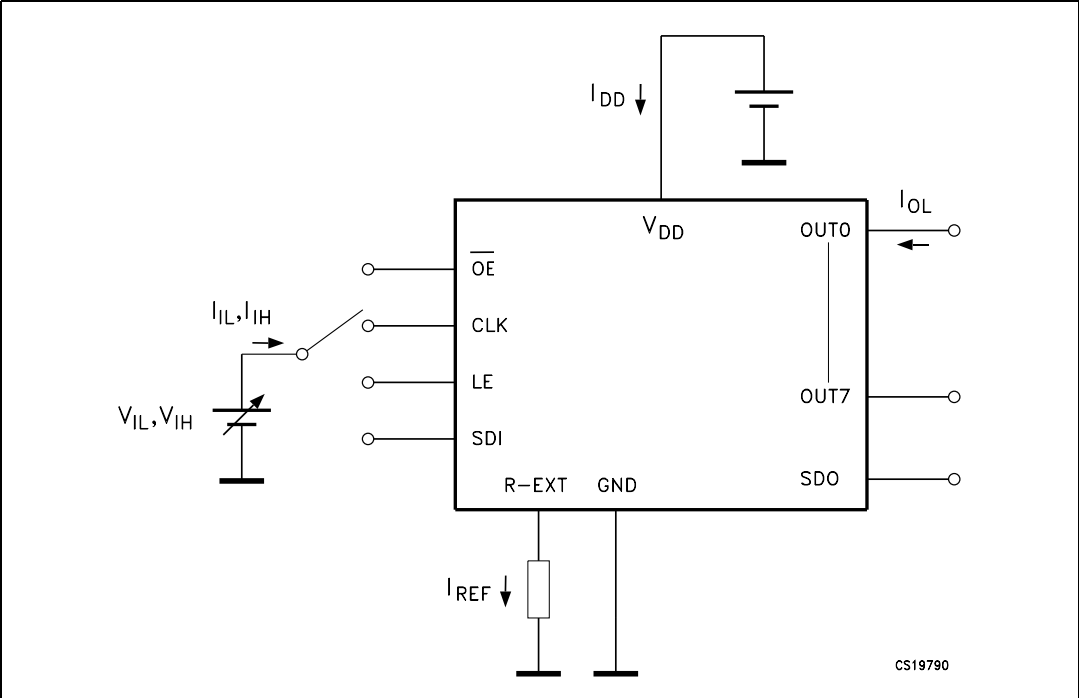
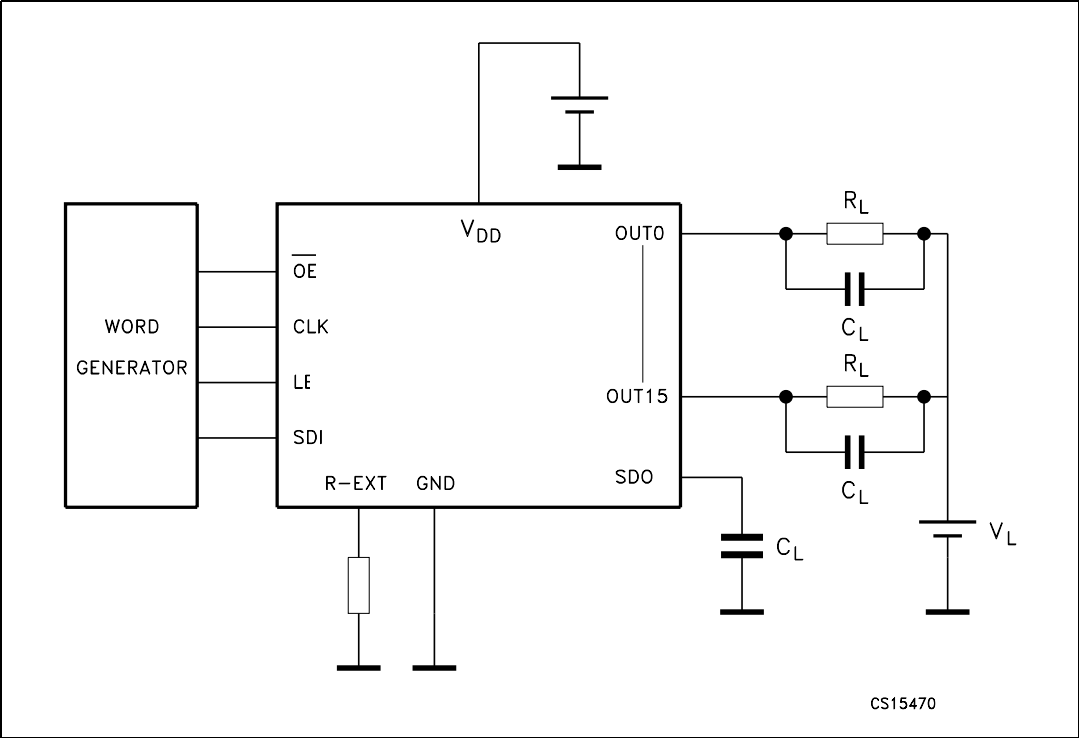


Figure 14. AC characteristics

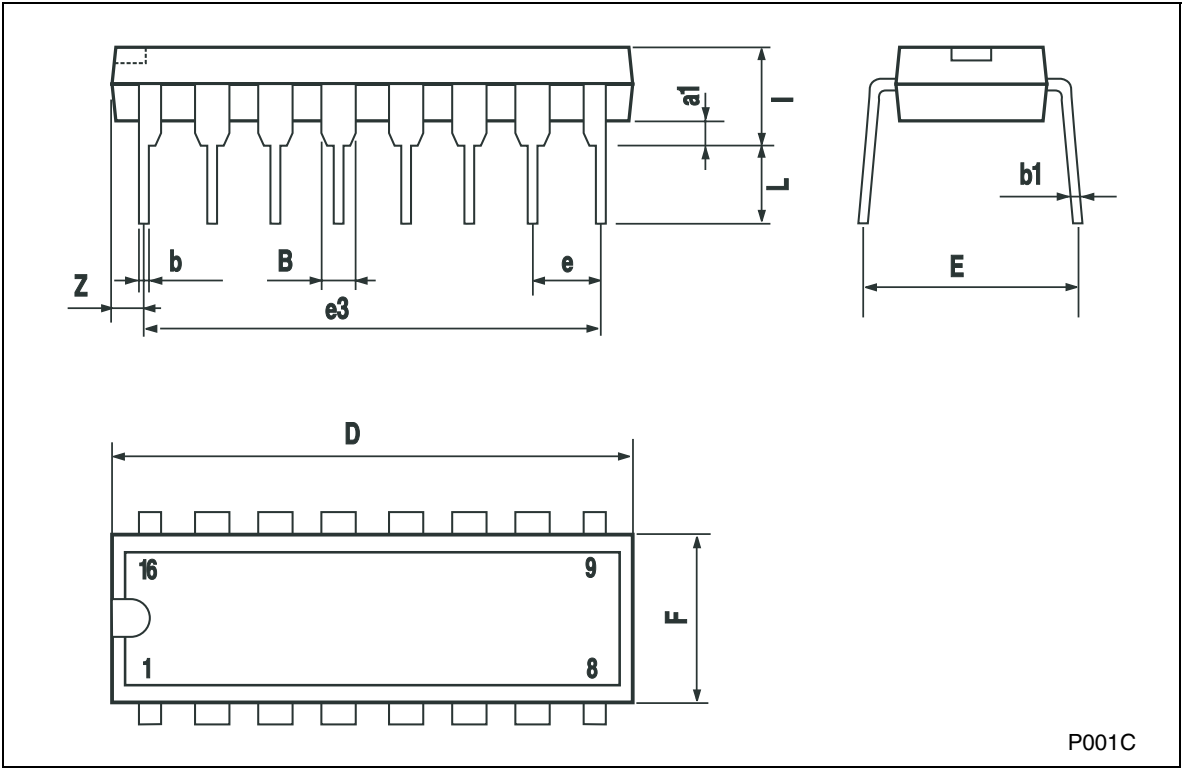


10 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

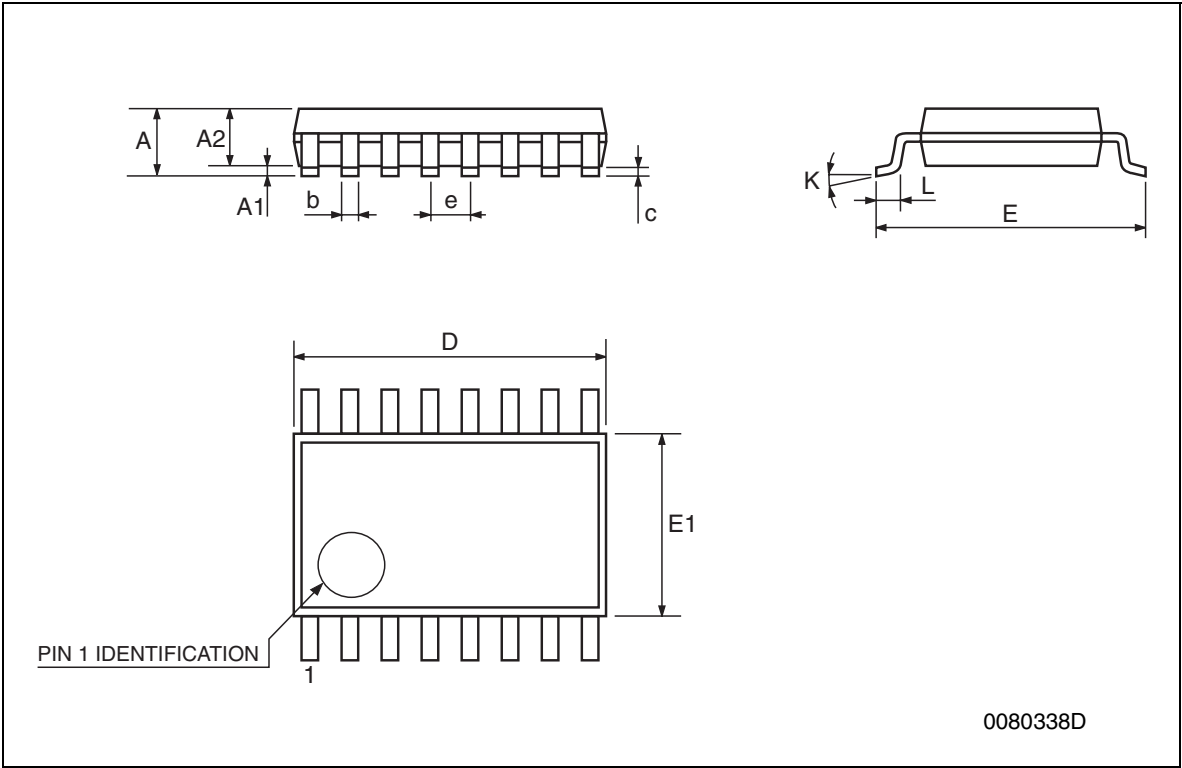
Plastic DIP-16 (0.25) MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
l			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050



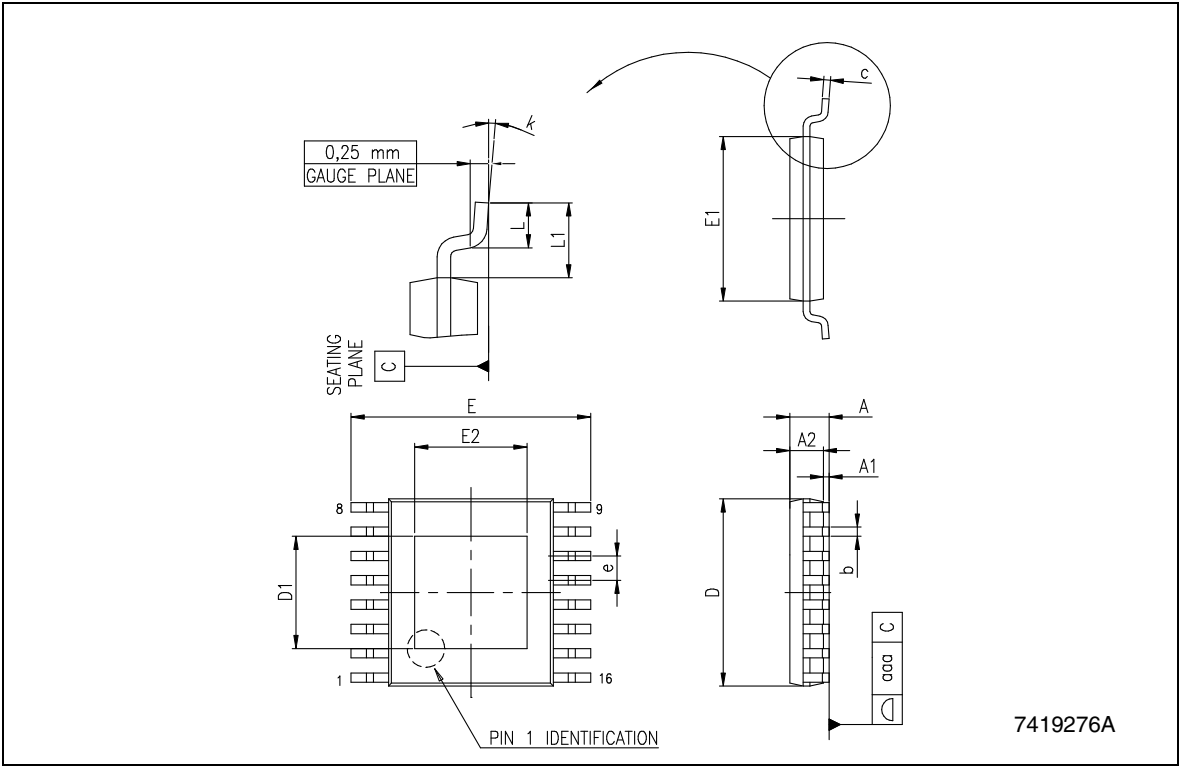
TSSOP16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



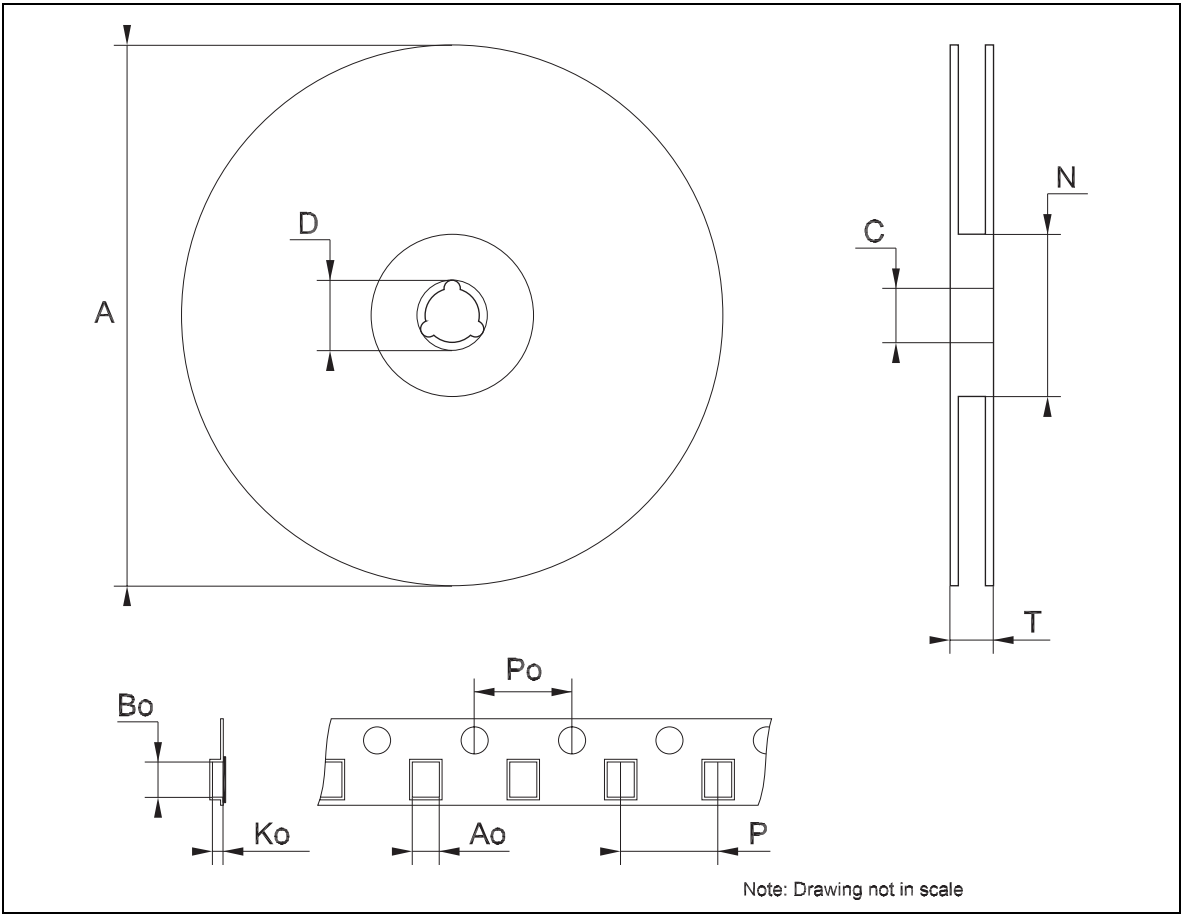
TSSOP16 EXPOSED PAD MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1			0.15		0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
D1	1.7			0.067		
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.5	0.169	0.173	0.177
E2	1.5			0.059		
e		0.65			0.0256	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



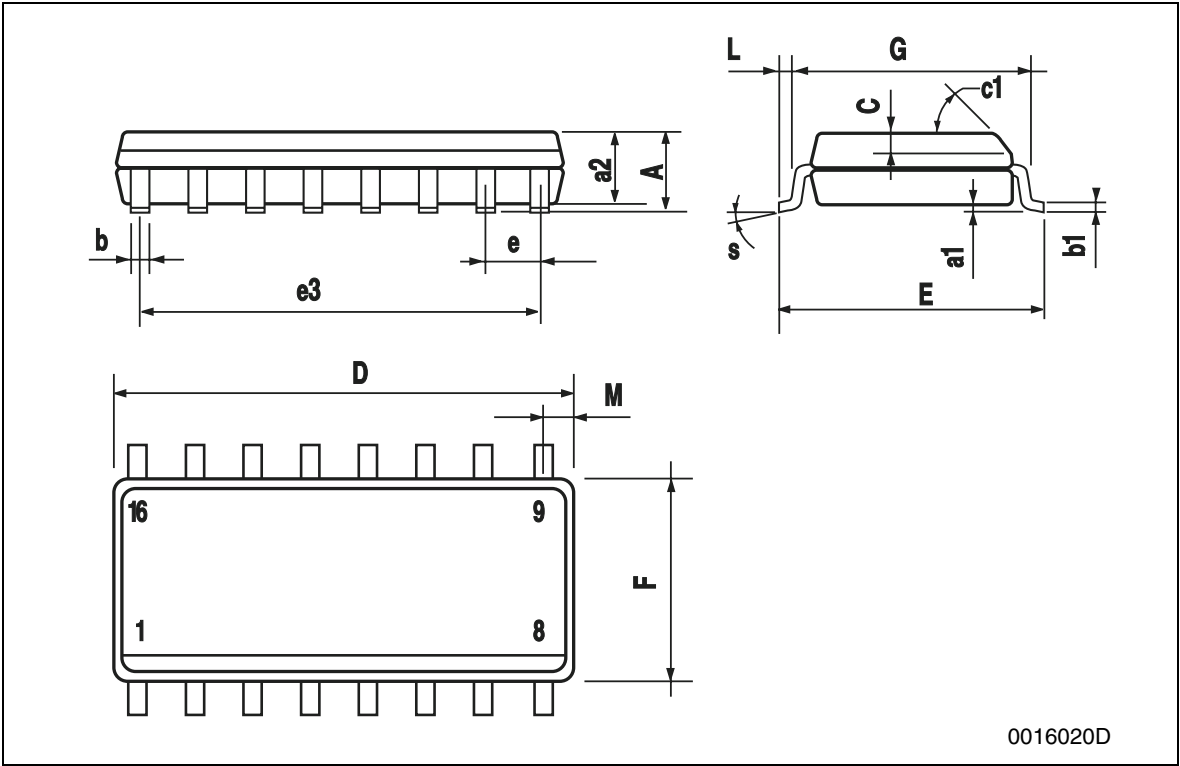
Tape & Reel TSSOP16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.7		6.9	0.264		0.272
Bo	5.3		5.5	0.209		0.217
Ko	1.6		1.8	0.063		0.071
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



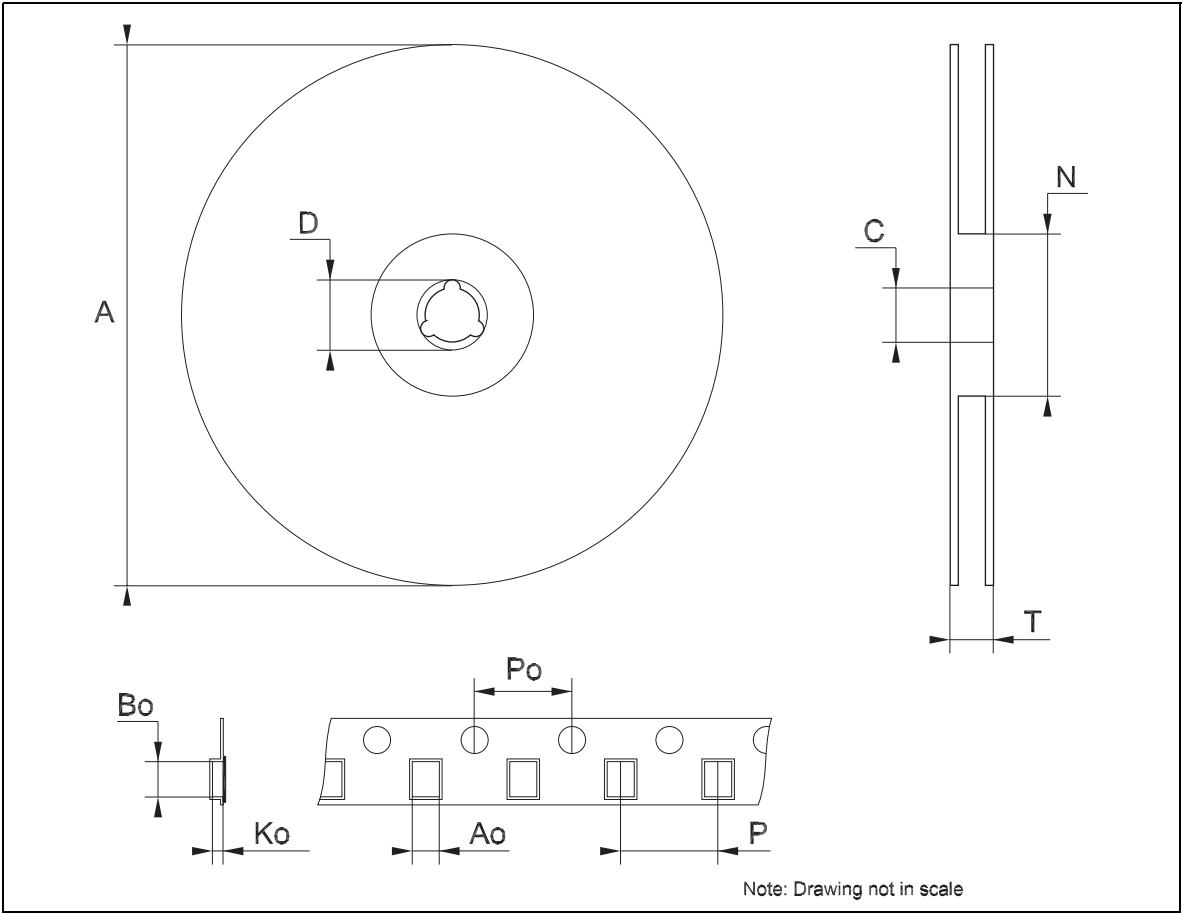
SO-16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.25	0.004		0.010
a2			1.64			0.063
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.62			0.024
S	8° (max.)					



Tape & Reel SO-16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.45		6.65	0.254		0.262
Bo	10.3		10.5	0.406		0.414
Ko	2.1		2.3	0.082		0.090
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



11 Revision history

Table 11. Revision history

Date	Revision	Changes
23-May-2007	1	First release
28-Jun-2007	2	Updated Table 7 on page 7

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